



Product Change Notification

Change Notification #: 114698 - 00
Change Title: Intel® INCA™ IP1 PSB21553 Chipset,
PCN 114698-00, Product Discontinuance,
End Of Life
Date of Publication: June 20, 2016

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	Dec 31, 2016
Last Product Discontinuance Shipment Date:	Jun 30, 2017

Description of Change to the Customer:

Intel is announcing the discontinuance of the product listed within the affected product table within this PCN notice.

The affected product is being discontinued due to low demand.

Customers should place their Last Time Orders by December 31, 2016 and delivery of all orders must be taken no later than June 30, 2017.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand and place your "Last Product Discontinuance Orders" in accordance with the "Key Milestones" listed above.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#	Stepping	Recommended Replacement Product Code	Recommended Replacement MM#
Intel® INCA™ IP1 PSB21553 Chipset	PSB21553E	S LLDC	946167	A4	PSB21653EL	946308

PCN Revision History:

Date of Revision: June 20, 2016	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

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